



#### Product Summary

Device	BV <sub>DSS</sub>	R <sub>DS(ON)</sub>	I <sub>D</sub> @T <sub>A</sub> = +25°C
Q1	20V	0.45Ω @ V <sub>GS</sub> = 4.5V	1066mA
Q2	-20V	0.75Ω @ V <sub>GS</sub> = -4.5V	-845mA

## Description

This new generation MOSFET has been designed to minimize the onstate resistance (R<sub>DS(ON)</sub>) and yet maintain superior switching performance, making it ideal for high efficiency power management applications.

## Applications

- Battery Operated Systems and Solid-State Relays
- Drivers: Relays, Solenoids, Lamps, Hammers, Displays, Memories. Transistors. etc.
- Power Supply Converter Circuits

#### COMPLEMENTARY PAIR ENHANCEMENT MODE MOSFET

#### **Features and Benefits**

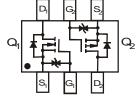
- Low On-Resistance
- Low Gate Threshold Voltage
- Low Input Capacitance
- Fast Switching Speed
- Low Input/Output Leakage
- Complementary Pair MOSFET
- Ultra-Small Surface Mount Package
- ESD Protected
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

## **Mechanical Data**

- Case: SOT363
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208@3)
- Terminal Connections: See Diagram
- Weight: 0.006 grams (Approximate)



Top View



Top View Internal Schematic

## Ordering Information (Note 5)

Part Number	Compliance	Case	Packaging				
DMG1016UDW-7	Standard	SOT363	3000/Tape & Reel				
DMG1016UDWQ-7	Automotive	SOT363	3000/Tape & Reel				
Notes: 1. No purposely added lead.	lotes: 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS), 2011/65/EU (RoHS 2) & 2015/863/EU (RoHS 3) compliant.						

2. See https://www.diodes.com/quality/lead-free/ for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free

CA1 = Product Type Marking Code

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to https://www.diodes.com/quality/.

5. For packaging details, go to our website at https://www.diodes.com/design/support/packaging/diodes-packaging/.

# **Marking Information**

Date Code Ke	₽Y			CA1	M M	Y or $\overline{Y}$	= Year (e	e Code Marki ex: F = 2018) 9 = Septembe	-			
Year	2008	20	09	2010	~	20	18	2019	2020	20	21	2022
Code	V	V	V	Х	~	F	F	G	Н		I	J
Month	Jan	Feb	Mar	Apr	Мау	Jun	Jul	Aug	Sep	Oct	Nov	Dec
Code	1	2	3	4	5	6	7	8	9	0	Ν	D

DMG1016UDW Document number: DS31860 Rev. 8 - 2



## Thermal Characteristics (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Value	Unit
Total Power Dissipation (Note 6)	PD	330	mW
Thermal Resistance, Junction to Ambient (Note 6)	$R_{ extsf{ heta}JA}$	379	°C/W
Operating and Storage Temperature Range	T <sub>J,</sub> T <sub>STG</sub>	-55 to +150	°C

## Maximum Ratings N-CHANNEL – Q1 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage	V <sub>DSS</sub>	20	V		
Gate-Source Voltage	V <sub>GSS</sub>	±6	V		
Continuous Drain Current (Note 6) State $T_A = +25^{\circ}C$ State $T_A = +85^{\circ}C$			ID	1066 690	mA
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	I <sub>DM</sub>	3.2	А		

## Maximum Ratings P-CHANNEL – Q2 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit	
Drain-Source Voltage		V <sub>DSS</sub>	-20	V	
Gate-Source Voltage	V <sub>GSS</sub>	±6	V		
Continuous Drain Current (Note 6)Steady State $T_A = +25^{\circ}C$ $T_A = +85^{\circ}C$			ID	-845 -548	mA
Pulsed Drain Current (10µs Pulse, Duty Cycle = 1%	I <sub>DM</sub>	-2.2	А		

## **Electrical Characteristics N-CHANNEL – Q1** (@T<sub>A</sub> = +25°C, unless otherwise specified.)

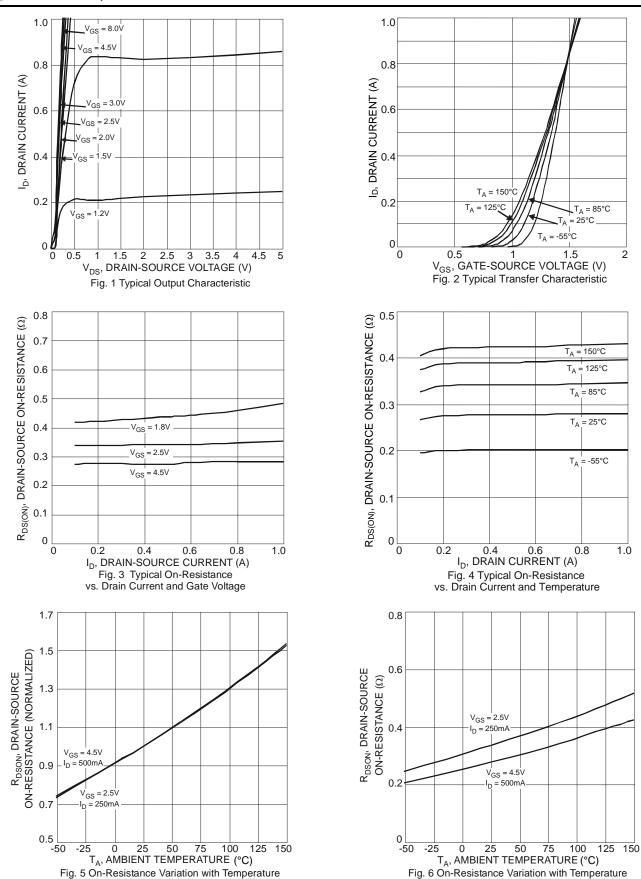
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)						1
Drain-Source Breakdown Voltage	BV <sub>DSS</sub>	20		_	V	V <sub>GS</sub> = 0V, I <sub>D</sub> = 250µA
Zero Gate Voltage Drain Current @T <sub>C</sub> = +25°C	I <sub>DSS</sub>	_		100	nA	V <sub>DS</sub> =20V, V <sub>GS</sub> = 0V
Gate-Source Leakage	I <sub>GSS</sub>	_		±1.0	μA	$V_{GS} = \pm 4.5 V, V_{DS} = 0 V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	0.5	_	1.0	V	$V_{DS} = V_{GS}$ , $I_D = 250 \mu A$
			0.3	0.45		$V_{GS} = 4.5V, I_D = 600mA$
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	—	0.4	0.6	Ω	$V_{GS} = 2.5V, I_D = 500mA$
			0.5	0.75		$V_{GS} = 1.8V, I_D = 350mA$
Forward Transfer Admittance			1.4	_	S	$V_{DS} = 10V, I_D = 400mA$
Diode Forward Voltage (Note 7)			0.7	1.2	V	$V_{GS} = 0V, I_{S} = 150mA$
DYNAMIC CHARACTERISTICS (Note 8)			•			
Input Capacitance	Ciss		60.67		pF	
Output Capacitance	Coss		9.68		pF	$V_{DS} = 10V, V_{GS} = 0V,$ - f = 1.0MHz
Reverse Transfer Capacitance	C <sub>rss</sub>		5.37		pF	
Total Gate Charge	Qg		736.6		nC	
Gate-Source Charge Gate-Drain Charge			93.6		nC	$V_{GS} = 4.5V, V_{DS} = 10V,$
			116.6	-	nC	$-I_D = 250 \text{mA}$
Turn-On Delay Time		_	5.1	_	ns	
Turn-On Rise Time			7.4		ns	$V_{DD} = 10V, V_{GS} = 4.5V,$
Turn-Off Delay Time	t <sub>D(OFF)</sub>	-	26.7	_	ns	$R_L = 47\Omega, R_G = 10\Omega$
Turn-Off Fall Time	t <sub>F</sub>		12.3		ns	

Notes: 6. Device mounted on FR-4 PCB with minimum recommended pad layout.

Short duration pulse test used to minimize self-heating effect.
Guaranteed by design. Not subject to production testing.



#### N-CHANNEL - Q1

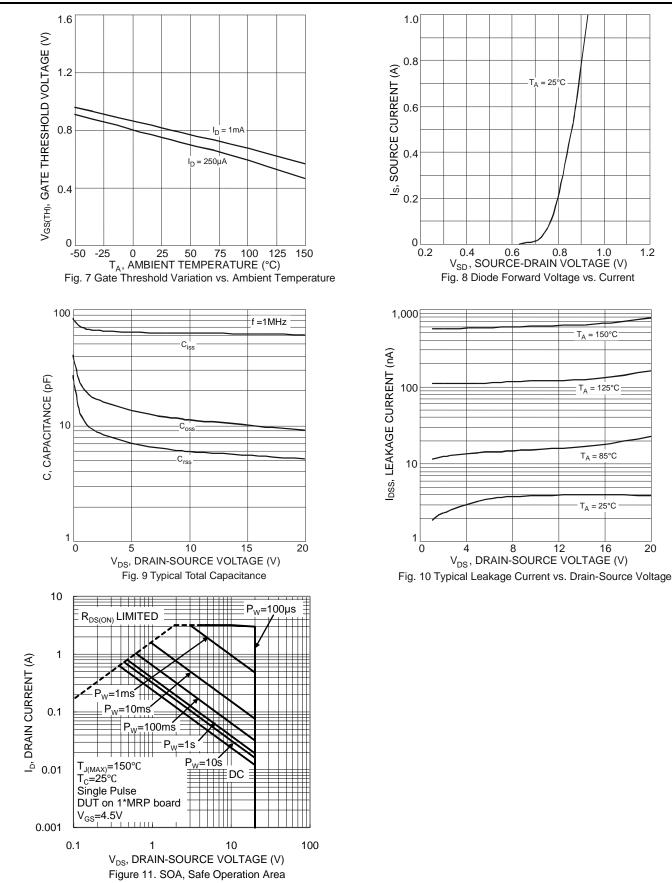




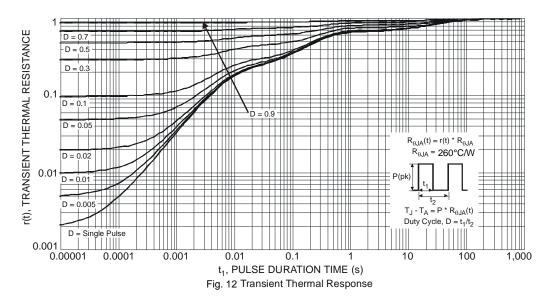
# N-CHANNEL – Q1 (Cont.)

1.2

20









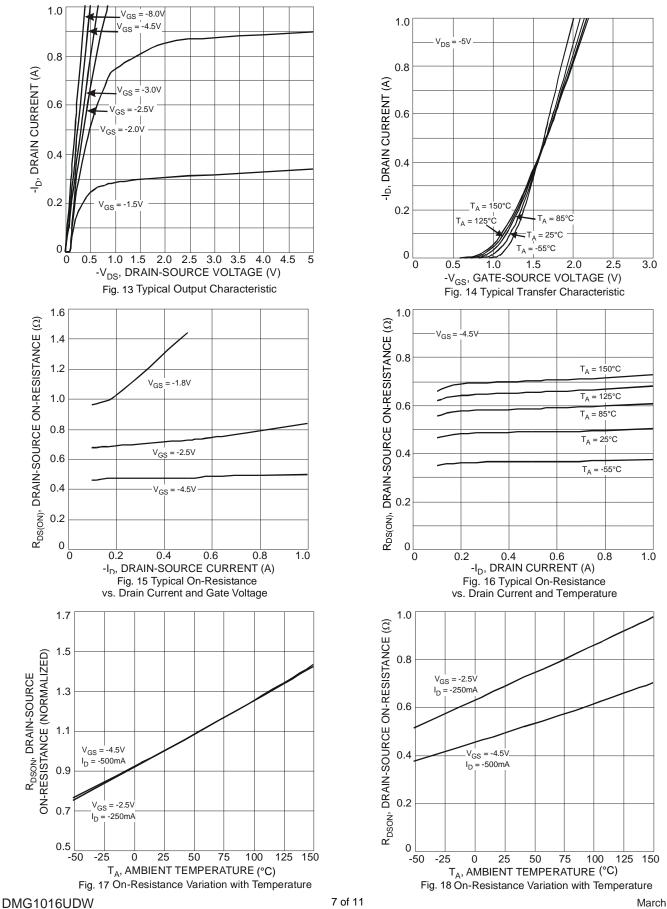
# Electrical Characteristics P-CHANNEL – Q2 (@T<sub>A</sub> = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
OFF CHARACTERISTICS (Note 7)			- 76			
Drain-Source Breakdown Voltage		-20	_		V	$V_{GS} = 0V, I_D = -250 \mu A$
Zero Gate Voltage Drain Current $@T_C = +25^{\circ}C$		—	—	-100	nA	$V_{DS} = -20V, V_{GS} = 0V$
Gate-Source Leakage	IGSS	—	—	±2.0	μA	$V_{GS} = \pm 4.5 V, V_{DS} = 0 V$
ON CHARACTERISTICS (Note 7)						
Gate Threshold Voltage	V <sub>GS(TH)</sub>	-0.5	—	-1.0	V	$V_{DS} = V_{GS}$ , $I_D = -250 \mu A$
			0.5	0.75		$V_{GS}$ = -4.5V, $I_{D}$ = -430mA
Static Drain-Source On-Resistance	R <sub>DS(ON)</sub>	—	0.7	1.05	Ω	$V_{GS}$ = -2.5V, $I_{D}$ = -300mA
			1.0	1.5		$V_{GS} = -1.8V, I_D = -150mA$
Forward Transfer Admittance	Y <sub>fs</sub>	_	0.9		S	$V_{DS} = -10V, I_D = -250mA$
Diode Forward Voltage (Note 7)		_	-0.8	-1.2	V	$V_{GS} = 0V, I_{S} = -150mA$
DYNAMIC CHARACTERISTICS (Note 8)						
Input Capacitance	Ciss	—	59.76		pF	
Output Capacitance	Coss	—	12.07	_	pF	V <sub>DS</sub> = -16V, V <sub>GS</sub> = 0V, f = 1.0MHz
Reverse Transfer Capacitance	C <sub>rss</sub>	—	6.36	—	pF	
Total Gate Charge	Qg	—	622.4	—	рС	
Gate-Source Charge Gate-Drain Charge		_	100.3	_	рС	$V_{GS} = -4.5V, V_{DS} = -10V,$
		_	132.2	_	рС	I <sub>D</sub> = -250mA
Turn-On Delay Time	t <sub>D(ON)</sub>	—	5.1	—	ns	
Turn-On Rise Time			8.1	_	ns	$V_{DS} = -10V, V_{GS} = -4.5V,$
Turn-Off Delay Time		_	28.4	—	ns	$R_G = 10\Omega, R_L = 47\Omega$
Turn-Off Fall Time	t <sub>F</sub>	_	20.72	_	ns	

 7. Short duration pulse test used to minimize self-heating effect.
8. Guaranteed by design. Not subject to production testing Notes:



#### P-CHANNEL - Q2



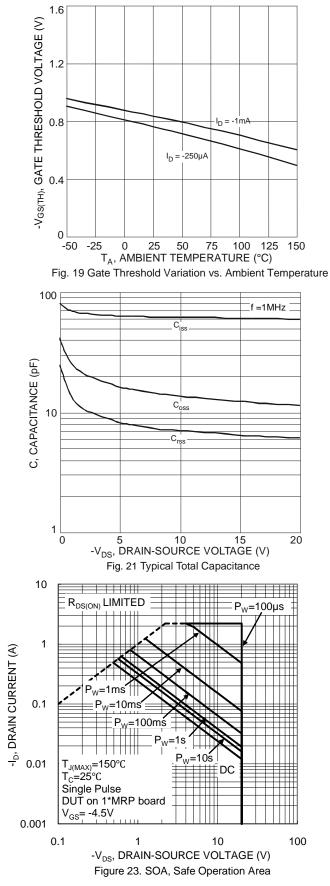
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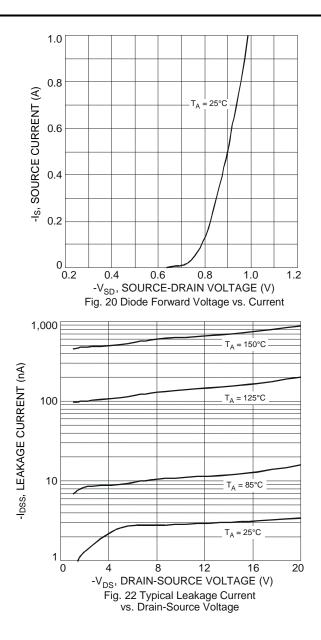
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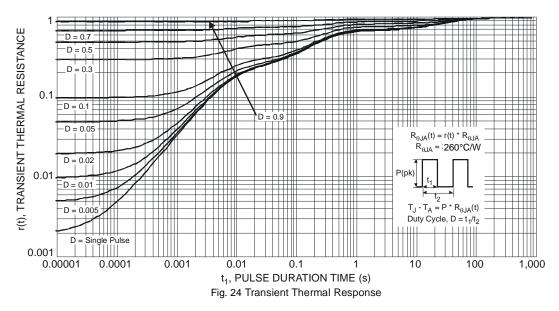








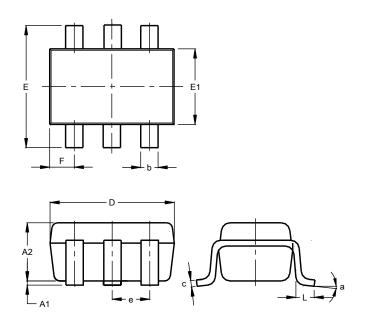






## **Package Outline Dimensions**

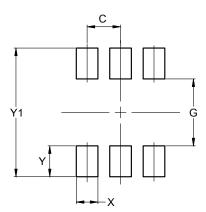
Please see http://www.diodes.com/package-outlines.html for the latest version.



		T363						
Dim	Min	Min Max Typ						
A1	0.00	0.10	0.05					
A2	0.90	1.00	0.95					
b	0.10	0.30	0.25					
c	0.10	0.22	0.11					
D	1.80	2.20	2.15					
Е	2.00	2.20	2.10					
E1	1.15	1.35	1.30					
е	C	).650 E	SC					
F	0.40	0.45	0.425					
L	0.25	0.40	0.30					
а								
All I	Dimen	sions	in mm					

## Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	0.650
G	1.300
X	0.420
Y	0.600
Y1	2.500

SOT363

SOT363



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